

Two-line TVS Diode

## **General Description**

The AOZ8222DI-05 is a two-line transient voltage suppressor diode designed to protect voltage sensitive electronics from high transient conditions and ESD.

This device incorporates two TVS diodes in an ultra-small DFN 1.0  $\times$  0.6 package. During transient conditions, the TVS diodes directs the transient to ground. The AOZ8222DI-05 may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ( $\pm$  15 kV air,  $\pm$  8 kV contact discharge).

The AOZ8222DI-05 comes in an RoHS compliant 3-lead DFN package and is rated over a -40 °C to +85 °C ambient temperature range.

The ultra-small 1.0 mm x 0.6 mm x 0.5 mm DFN package makes it ideal for applications where PCB space is a premium. The small size and high ESD protection makes it ideal for protecting voltage sensitive electronics from high transient conditions and ESD.

#### **Features**

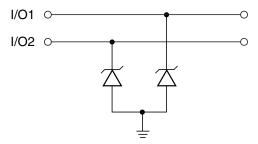
- ESD protection for high-speed data lines:
  - Exceeds IEC 61000-4-2 (ESD): ± 20 kV (air),
     ± 20 kV (contact)
  - Human Body Model (HBM) ± 30 kV
- Small package saves board space
- Low insertion loss
- Low clamping voltage
- Low operating voltage: 5 V

## **Applications**

- Portable handheld devices
- Keypads, data lines, buttons
- Notebook computers
- Digital Cameras
- Portable GPS
- MP3 players

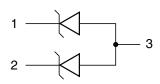


# Typical Application



**Unidirection Protection of Two Line** 

# **Pin Configuration**





## **Ordering Information**

Part Number	Ambient Temperature Range	Package	Environmental		
AOZ8222DI-05	-40 °C to +85 °C	DFN 1.0 x 0.6-3L	Green Product		



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/web/quality/rohs\_compliant.jsp for additional information.

### **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Peak Pulse Current, t <sub>P</sub> = 8/20 μs	5.5 A
Peak Pulse Power, t <sub>P</sub> = 8/20 μs	50 W
Storage Temperature (T <sub>S</sub> )	-65 °C to +150 °C
ESD Rating per IEC61000-4-2, Contact <sup>(1)</sup>	± 20 kV
ESD Rating per IEC61000-4-2, Air <sup>(1)</sup>	± 20 kV
ESoD Rating per Human Body Model <sup>(2)</sup>	± 30 kV

#### Notes:

- 1. IEC 61000-4-2 discharge with C\_Discharge = 150 pF, R\_Discharge = 330  $\Omega$ .
- 2. Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge}$  = 100 pF,  $R_{Discharge}$  = 1.5 k $\Omega$ .

# **Maximum Operating Ratings**

Parameter	Rating
Junction Temperature (T <sub>J</sub> )	-40 °C to +85 °C

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## **Electrical Characteristics**

 $T_A = 25$ °C unless otherwise specified. Specifications in **BOLD** indicate a temperature range of -40°C to +85°C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V <sub>RWM</sub>	Reverse Working Voltage	Between I/O and VN <sup>(3)</sup>			5.0	V
V <sub>BR</sub>	Reverse Breakdown Voltage	I <sub>T</sub> = 100 μA, between I/O and VN <sup>(4)</sup>	6.0			V
I <sub>R</sub>	Reverse Leakage Current	V <sub>RWM</sub> = 5 V, between I/O and VN			1	μΑ
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> = 15 mA	0.70	0.85	1	V
V <sub>CL</sub>	Channel Clamp Voltage Positive Transients Negative Transient	I <sub>PP</sub> = 1 A, tp = 100 ns, any I/O pin to Ground <sup>(5)</sup>			8.0 -2.0	V V
	Channel Clamp Voltage Positive Transients Negative Transient	$I_{PP} = 5 \text{ A}$ , tp = 100 ns, any I/O pin to Ground <sup>(5)</sup>			9.0 -5.0	V V
	Channel Clamp Voltage Positive Transients Negative Transient	$I_{PP}$ = 12 A, tp = 100 ns, any I/O pin to Ground <sup>(5)</sup>			10.0 -10.0	V V
C <sub>j</sub>	Channel Input Capacitance	V <sub>R</sub> = 0 V, f = 1 MHz, between I/O pins		8	9	pF
		V <sub>R</sub> = 0 V, f = 1 MHz, any I/O pin to Ground		15	18	pF

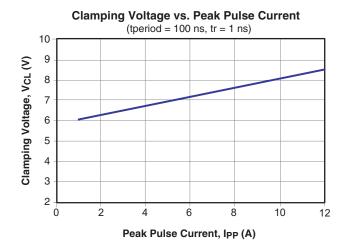
### Notes:

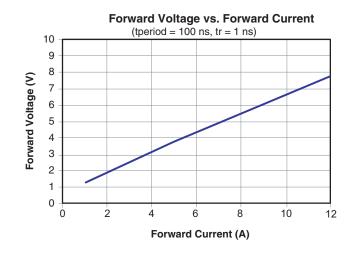
- $3. \ The \ working \ peak \ reverse \ voltage, \ V_{RWM}, \ should \ be \ equal \ to \ or \ greater \ than \ the \ DC \ or \ continuous \ peak \ operating \ voltage \ level.$
- 4.  $V_{BR}$  is measured at the pulse test current  $I_{T}$ .
- 5. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

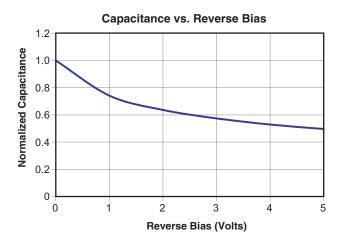
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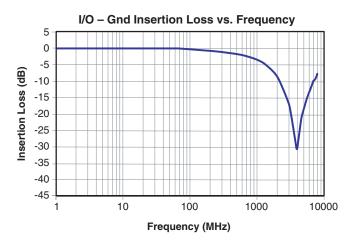


# **Typical Performance Characteristics**





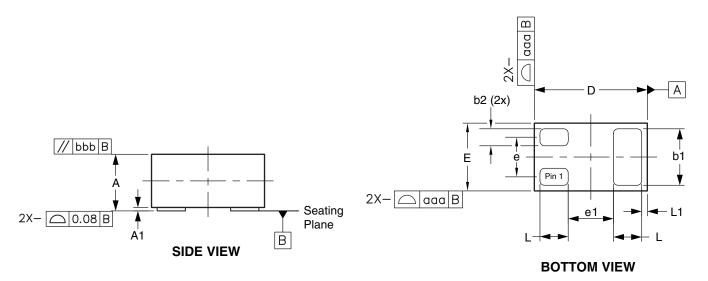




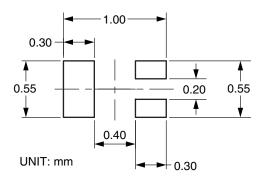
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# Package Dimensions, DFN 1.0 x 0.6, 3L



### RECOMMENDED LAND PATTERN



### **Dimensions in millimeters**

Min.	Nom.	Max.		
0.50	0.52	0.55		
0.00	0.03	0.05		
0.45	0.50	0.55		
0.10	0.15	0.20		
0.95	1.00	1.075		
0.55	0.60	0.675		
_	0.35	_		
_	0.40			
0.20	0.25	0.30		
_	0.05	_		
0.15				
	0.05			
	0.50 0.00 0.45 0.10 0.95 0.55	0.50		

### **Dimensions in inches**

Symbols	Min.	Nom.	Max.
Α	0.019	0.020	0.022
A1	0.000	0.001	0.002
b1	0.018	0.020	0.022
b2	0.004	0.006	0.008
D	0.037	0.039	0.042
Е	0.022	0.024	0.027
е		0.014	
e1		0.016	
L	0.008	0.010	0.012
L1	_	0.002	_
aaa		0.006	
bbb		0.002	

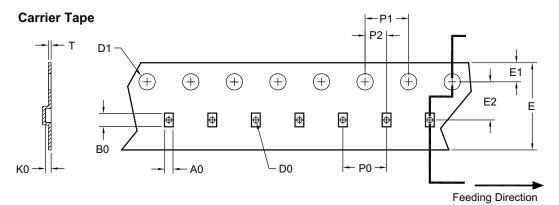
#### Notes:

- 1. All dimensions are in millimeters, angles are in degrees.
- 2. Coplanarity applies to the exposed heat sink slug as well as the terminals.

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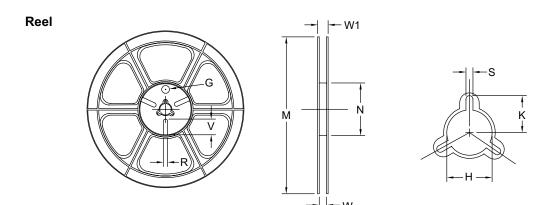


# Tape and Reel Dimensions, DFN 1.0 x 0.6, 3L



UNIT: mm

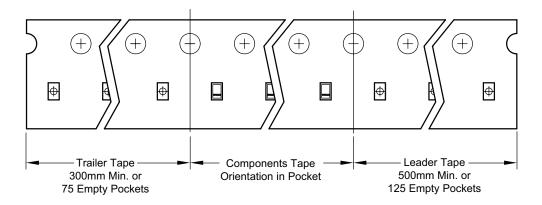
Package	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
DFN 1.0x0.6	0.76	1.21	0.53	ø0.50	ø1.50	8.00	1.75	3.50	4.00	4.0	2.0	0.254
(8 mm)	±0.05	±0.05	±0.05	±0.05	±0.10	+0.30/-0.10	±0.1	±0.05	±0.10	±0.10	±0.05	±0.02



UNIT: mm

Tape Size	Reel Size	М	N	W	W1	Н	K	S	G	R	٧
8mm	ø178	ø178 ±0.5	ø55 +1	8.4 +1.5/-0	14.4. Max.	ø13.0 ±0.5	2.0 ±0.5	2.0 ±0.5	N/A	N/A	N/A

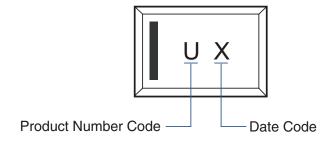
### Leader / Trailer & Orientation



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## **Part Marking**



This data sheet contains preliminary data; supplementary data may be published at a later date. Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

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